		***				<u> </u>		RE	EVIS	IONS										
LTR://	5962-9067901HXC"(# DESCRIPTION										DA	TE (	YR-MO-	DA)		APPRO	OVED			
A E	75962-906/901日XC (大)が前 Made technical changes to table I. Ed					Edit	orial		91	-11-	15		XI	at	Lust	6				
	cha	nges	thro	ougho	ut.							l				İ				
																				ŀ
																				1
	1	<u> </u>				T	Γ	· · · · · ·	T	T	T	<u> </u>				<u> </u>				
REV	<del> </del>								+-	+	+					-				
SHEET	<b></b>	· · · · · · · · · · · · · · · · · · ·							┼		+		ļ					<del>                                     </del>		
REV	<del> </del>						<u> </u>		<del> </del>	+-	-					<del> </del>		<del> </del>		
SHEET	<u>.</u>					<u> </u>			<u> </u>									<del> </del>		
REV STAT				RE	:V		A	A	A	A	Α	Α	A	A .	A .	^		┼	<del>                                     </del>	
OF SHEET	.'S 			SH	EET		1	2	3	4	5	6	7	8	9	10	<u> </u>		<u> </u>	
PMIC N/A				PREP	ARED	вч					DEFENSE ELECTRONICS SUPPLY CENTER									
STANDARDIZED MILITARY  Thue Man			120	RÙ	20		,	]	TYAC	ON, C	OIHO	454	.44							
			7																	
				[11	re!	<u>/////</u>	CAS	_	$\dashv$	CROC	TDA	11TM	ΩD	י ע כו יו	PT∩N	IAT.	ΔΜΦΤ	TTTI.	ER.	
		APPE	ROVED	вү	? <b>~</b> 3	f Llev	1		WER /				ERA.	LION	IALI .	71111 1				
THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE				E Cla	773 (	( ()2/	ce.	<u> </u>	┤ ¯`	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,										
			DRAU	VING A 91	PPROVA -03-06	L DATE			-			7E CC	NDE	1		062	906	79		
AMSC N/	Α			DEV	ISTON	LEVEL					ZE A	CAGE CODE 67268		5962-90679						
AHSC N	••			, KEV	FOTOM	A						1	1		OF	1	0			
						^					эн <b>е́ЕТ</b>		1		VI					
DESC FORM 10																				

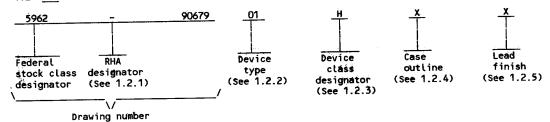
<u>DISTRIBUTION STATEMENT A</u>. Approved for public release; distribution is unlimited.

5962-E398

### 1. SCOPE

直间 59600e90代码 (nawing forms) and of a one part — one part number documentation system (see 6.6 herein).
This drawing describes device requirements for hybrid microcircuits to be processed in accordance with MIL-H-36534.
Two product assurance classes, military high reliability (device class H) and space application (device class K) and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN).
When available, a choice of radiation hardness assurance levels are reflected in the PIN.

1.2 PIN. The PIN shall be as shown in the following example:



1.2.1 <u>Radiation hardness assurance (RHA) designator</u>. Device classes H and K RHA marked devices shall meet the MIL-H-38534 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

Device type	Generic number	<u>Circuit function</u>
01	PAO2	Power operational amplifier

1.2.3 <u>Device class designator</u>. This device class designator shall be a single letter identifying the product assurance level as follows:

<u>Device class</u>

H or K

Device requirements documentation

Certification and qualification to MIL-H-38534

1.2.4 <u>Case outline(s)</u>. The case outline(s) shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline Letter

X See figure 1 (8-lead, 1.55" x .250") TO-3 package

1.2.5 <u>lead finish</u>. The lead finish shall be as specified in MIL-H-38534 for classes H and K. Finish letter "X" shall not be marked on the microcircuit or its packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are considered acceptable and interchangeable without preference.

	the state of the s		
STANDARDIZED	SIZE A		5962-90679
MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	10 A	REVISION LEVEL	SHEET 2

1.3 Absolute maximum ratings.			
Power dissipation (P <sub>D</sub> ) 1/2/ ——————————————————————————————————	Unless otherwis	+300°C +150°C65°C to +150 ±15 V dc55°C to +125	og ng nse Index of
herein.	•		
SPECIFICATIONS			
MILETARY  MIL-M-38510 - Microcircuits, General Spe  MIL-H-38534 - Hybrid Microcircuits, Gene	cification for. ral Specification	ı for.	
STANDARDS			
MILITARY			
MIL-STD-480 - Configuration Control-Engi MISTD-883 - Test Methods and Procedure	neering Changes, s for Microelect	Deviations and Waivers. ronics.	
HANDBOCK			
MILLTARY			
MIL-HDBK-780 - Standardized Military Draw	rings.		
(Copies of the specifications, standards, and handbook r acquisition functions should be obtained from the contract	required by manufa ing activity or a	acturers in connection wi as directed by the contra	th specific cting activity.)
2.2 <u>Order of precedence</u> . In the event of a conflict bet references cited herein, the text of this drawing shall ta	tween the text of ake precedence.	this drawing and the	
1/ Derate 3.6°C/W above T <sub>C</sub> = +25°C. 2/ T <sub>C</sub> ≤ +25°C			
STANDARDIZED	SIZE A		5962-90679
MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 3

### 3. REQUIREMENTS

- 查询"59<u>62m9067790mHXC"t姞应硫</u> idual item requirements shall be in accordance with MIL-H-38534 and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-H-38534 and herein.
  - 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein and figure 1.
  - 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 2.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 Marking. Marking shall be in accordance with MIL-H-38534. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in QML-38534.
- 3.6 Manufacturer eligibility. In addition to the general requirements of MIL-H-38534, the manufacturer of the part described herein shall submit for DESC-ECT review and approval electrical test data (variables format) on 22 devices from the initial quality conformance inspection group A lot sample, produced on the certified line, for each device type listed herein. The data should also include a summary of all parameters manually tested, and for those which, if any, are guaranteed.
- 3.7 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to supply to this drawing. The certificate of compliance submitted to DESC-ECT shall affirm that the manufacturer's product meets the requirements of MIL-H-38534 and the requirements herein.
- 3.8 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-H-38534 shall be provided with each lot of microcircuits delivered to this drawing.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-H-38534.
- 4.2 <u>Screening</u>. Screening shall be in accordance with MIL-H-38534. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - (1) Test condition D using the circuit submitted with the certificate of compliance (see 3.7 herein).
    - (2)  $T_C$  as specified in accordance with table I of method 1015 of MIL-STD-883.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
  - c. Constant acceleration may be performed after burn-in with qualifying activity approval.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90679
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 4

		TABLE I. Electrical performa	nce charact	<u>eristics</u> .			
查询"5962-9067901	<b>҅Ӊ</b>	应商 Conditions <u>1/</u> -55°C ≤ T <sub>C</sub> ≤ +125°C	Group A	Device type	Limits		Unit
		unless otherwise specified			Min	Max	
Quiescent current	IQ	V <sub>IN</sub> = 0 V, V <sub>S</sub> = ±15 V, ±R <sub>CL</sub> = 0.2Ω, V <sub>CM</sub> = 0 V <u>1</u> /	1 2,3	01		40 60	mA
Input offeet voltage	v <sub>os</sub>	$v_{LN} = 0 \text{ v, } v_{S} = \pm 15 \text{ v,} \\ \pm R_{CL} = 0.2_{\Omega}, \text{ G} = 100 \text{ 1/}$	1 2 3	01	-10 -15 -14	+10   +15   +14	mV
		$v_{IN} = 0 \text{ v, } v_{S} = \pm 7 \text{ v,} \\ \pm R_{CL} = 0.2 \Omega, \text{ G} = 100 \text{ 1/}$	1 2 3	01	-11.6 -16.6 -15.6	+11.6 +16.6 +15.6	mV
	 	$V_{IN} = 0 \text{ V, } V_{S} = \pm 19 \text{ V,} \\ \pm R_{CL} = 0.2 \Omega, \text{ G} = 100 \text{ 1/}$	1 2 3	01	   -10.8   -15.8   -14.8	+10.8   +15.8   +14.8	mV
Input bias current, +IN	+I <sub>B</sub>	V <sub>IN</sub> = 0 V, V <sub>S</sub> = ±15 V, R <sub>BIAS</sub> ≤ 100 M <sub>Ω</sub>	1 2 3	01		200 30 200	pA nA pA
Input bias current, -IN	-I <sub>B</sub>	V <sub>IN</sub> = 0 V, V <sub>S</sub> = ±15 V, R <sub>BIAS</sub> ≤ 100 M <sub>Ω</sub>	1 2 3	01		200 30 200	pA nA pA
Input offset current	Ios	$V_{IN} = 0 \text{ V, } V_{S} = \pm 15 \text{ V,}$ $R_{BIAS} \le 100 \text{ M}_{\Omega}$	1 2 3	01		100 10 100	pA nA pA
Output voltage	v <sub>o</sub>	$R_L = 1\Omega$ , $I_O = 5$ A $V_S = \pm 9$ V, $T_C = +25$ °C and $-55$ °C	4,6	01	5		V
		$V_S = \pm 7 \text{ V}, R_L = 1_{\Omega}$ $I_O = 3 \text{ A}, T_C = +125 ^{\circ}\text{C}$	5	01	3		V
		$R_L = 500\Omega$ , $I_0 = 36 \text{ mA}$ , $V_S = \pm 19 \text{ V}$ ,	4,5,6	01	18		V
		$R_L = 5\Omega$ , $I_O = 2 A$ , $V_S = \pm 12 V$	4,5,6	01	10		v

See footnotes at end of table.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90679
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL A	SHEET 5

Test	Symbol	Conditions <u>1</u> /	Group A	Device type	Lin	Unit	
≦询"5962-9067901H.	XC"供应	Conditions 1/ -55°C ≤ I <sub>C</sub> ≤ +125°C Photosist Specified			   Min 	Max	
Current limi*s	I <sub>CL</sub>	$R_L = 1\Omega$ , $R_{CL} = 0.2\Omega$ , $V_S = \pm 9$ V, $V_C = +25$ °C 1/	4	01	2.6	3.9	A
Stability/noise	E <sub>N</sub>	G = 1, C <sub>L</sub> = 1.5 nF, V <sub>S</sub> = ±15 V	4,5,6	01		1	mV
Slew rate	s <sub>R</sub>	$R_L = 500_{\Omega}, V_S = \pm 18 V,$ $V_{IN} \ge 4 V_{p-p}$	4,6	01	13 8.5	100	V/μs
Open loop gain	A <sub>OL</sub>	$R_L = 500_{\Omega}, V_S = \pm 15 V,$ $f^L = 15 Hz, V_{IN}^2 = .2 V_{p-p}$	4,5,6	01	86		dB
Common mode rejection	CMR	V <sub>S</sub> = ±8.25 V, f = DC, V <sub>CM</sub> = ±2.25 V	4,5,6	01	70		dB

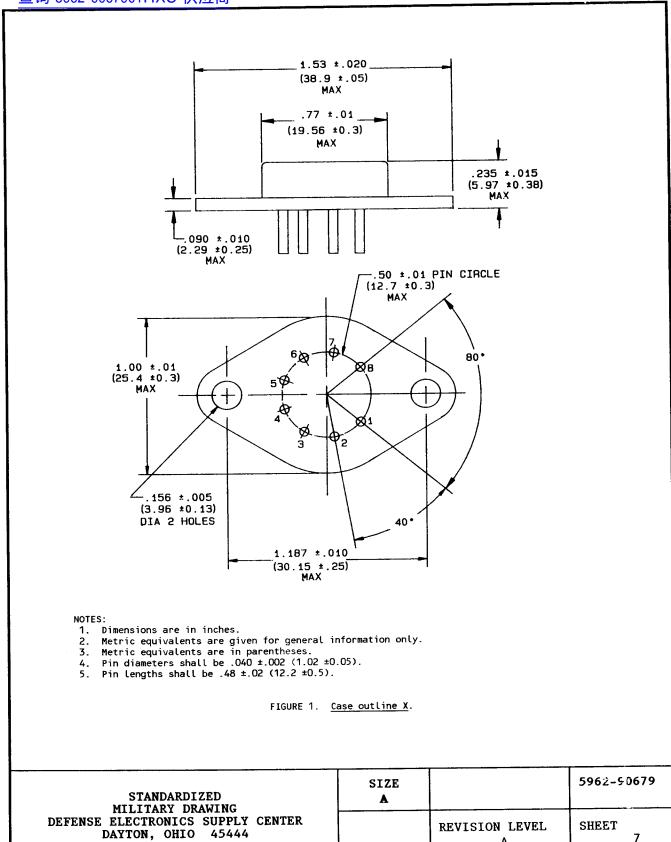
<sup>1/</sup> A current limiting resistor ( $R_{CL}$ ) is connected between  $C_{L}^{\pm}$  terminals and the  $\pm V_{S}$  terminals during these tests.

- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with MIL-H-38534 and as specified herein.
  - 4.3.1 Group A inspection. Group A inspection shall be in accordance with MIL-H-38534 and as follows:
    - a. Tests shall be as specified in table II herein.
    - b. Subgroups 7, 8, 9, 10, and 11 in table X, method 5008 of MIL-STD-883 shall be omitted.
  - 4.3.2 Group B inspection. Group B inspection shall be in accordance with MIL-H-38534.
- 4.3.3 <u>Group C inspection</u>. Group C inspection shall be in accordance with MIL-H-38534 and as follows:
  - a. End-point electrical parameters shall be as specified in table II herein.
  - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
    - (1) Test condition D using the circuit submitted with the certificate of compliance (see 3.7 herein).
    - (2)  $T_{C}$  as specified in accordance with table I of method 1005 of MIL-STD-883.
    - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
  - 4.3.4 Group D inspection. Group D inspection shall be in accordance with MIL-H-38534.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90679
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 6

DESC FORM 193A

JUL 91



# 查询"5962-9067901HXC"供应商

Device type	01
Case outline	X
Terminal number	Terminal connection
1 2 3 4 5 6 7 8	CL+ +Vs OUT OUT -IN +IN -Vs CL-

FIGURE 2. <u>Terminal connections</u>.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90679
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	the Child Children	REVISION LEVEL A	SHEET 8

TABLE II.	Electrical	test	requirements.
-----------	------------	------	---------------

MIL-STD-883 test requirements	Subgroups (per method 5008, group A test table)
Interim electrical parameters	
Final electrical test parameters	1*,2,3,4,5,6
Group A test requirements	1,2,3,4,5,6
Group C end-point electrical parameters	1,4
Group E end-point electrical parameters for RHA devices	Subgroups ** (per method 5005, group A test table)

\*PDA applies to subgroup 1.
\*\*When applicable to this standardized military drawing,
the subgroups shall be defined.

- 4.3.5 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes H and K shall be M, D, R, and H. RHA quality conformance inspection sample tests shall be performed at the RHA level specified in the acquisition document.
  - a. RHA tests for device classes H and K for levels M, D, R, and H shall be performed through each level to determine at what levels the devices meet the RHA requirements. These RHA tests shall be performed for initial qualification and after design or process changes which may affect the RHA performance of the device.
  - b. End-point electrical parameters shall be as specified in table II herein.
  - c. Prior to total dose irradiation, each selected sample shall be assembled in its qualified package. It shall pass the specified group A electrical parameters in table I for subgroups specified in table II herein.
  - d. For device classes H and K, the devices shall be subjected to radiation hardness assured tests as specified in MIL-H-38534 for RHA level being tested, and meet the postirradiation end-point electrical parameter limits as defined in table I at T<sub>A</sub> = +25°C ±5 percent, after exposure.
  - e. Prior to and during total dose irradiation testing, the devices shall be biased to establish a worst case condition as specified in the radiation exposure circuit.
  - f. For device classes H and K, subgroups 1 and 2 in table V, method 5005 of MIL-STD-883 shall be tested as appropriate for device construction.
  - g. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

## 5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-H-38534.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-30679
		REVISION LEVEL A	SHEET 9

DESC FORM 193A

JUL 91

#### 6. NOTES

- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 <u>Record of users</u>. Military and industrial users shall inform Defense Electronics Supply Center when a <u>system</u> application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DESC-ECT, telephone (513) 296-6047.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DESC-ECT, Dayton, Ohio 45444, or telephone (513) 296-5374.
- 6.6 One part one part number system. The one part one part number system described below has been developed to allow for transitions between identical generic devices covered by the four major microcircuit requirements documents (MIL-M-38510, MIL-H-38534, MIL-I-38535, and 1.2.1 of MIL-STD-883) without the necessity for the generation of unique PIN's. The four military requirements documents represent different class levels, and previously when a device manufacturer upgraded military product from one class level to another, the benefits of the upgraded product were unavailable to the Original Equipment Manufacturer (OEM), that was contractually locked into the original unique PIN. By establishing a one part number system covering all four documents, the OEM can acquire to the highest class level available for a given generic device to meet system needs without modifying the original contract parts selection criteria.

Military documentation format	Example PIN under new system	Manufacturing source listing	Document Listing
New MIL-M-38510 Military Detail Specifications (in the SMD format)	5962-XXXXXZZ(B or \$)YY	QPL-38510 (Part 1 or 2)	MIL-BUL-103
New MIL-H-38534 Standardized Military Drawings	5962-XXXXXZZ(H or K)YY	QML-38534	MIL-BUL-103
New MIL-I-38535 Standardized Military Drawings	5962-XXXXXZZ(Q or V)YY	QML-38535	MIL-BUL-103
New 1.2.1 ನ್ MIL-STD-883 Standardized Military Drawings	5962-XXXXXZZ(M)YY	MIL-BUL-103	MIL-BUL-103

6.7 <u>Sources of supply for device classes H and K</u>. Sources of supply for device classes H and K are listed in QML-38534. The vendors listed in QML-38534 have submitted a certificate of compliance (see 3.7 herein) to DESC-ECT and have agreed to this drawing.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90679
		REVISION LEVEL A	SHEET 10

DESC FORM 193A JUL 91

029342 \_ \_ -